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Thermoelectric properties of DC-sputtered filled skutterudite thin film

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The Yb filled CoSb3 skutterudite thermoelectric thin films were prepared by DC magnetron sputtering. The electrical conductivity, Seebeck coefficient, thermal conductivity, and figure of merit ZT of the samples are characterized in a temperature range of 300 K to 700 K. X-ray diffraction, scanning electron microscopy, and energy-dispersive X-ray spectroscopy are obtained to assess the phase composition and crystallinity of thin film samples at different heat treatment temperatures. Carrier concentrations and Hall mobilities are obtained from Hall Effect measurements, which provide further insight into the electrical conductivity and Seebeck coefficient mechanisms. The thermal conductivity of thin film filled skutterudite was found to be much less compared with bulk Yb filled CoSb3 skutterudite. In this work, the 1020 K heat treatment was adopted for thin film post process due to the high degree of crystallinity as well as avoiding reverse heating effect. Thin film samples of different thicknesses were prepared with the same sputtering deposition rate and maximum ZT of 0.48 was achieved at 700 K for the 130 nm thick sample. This value was between half and one third of the bulk figure of merit which was due to the lower Hall mobility. © 2015 AIP Publishing LLC. [http://dx.doi.org/10.1063/1.4916238]

I. INTRODUCTION

Thermoelectric generators allow the direct solid-state conversion between thermal and electrical energy,1 which are of particular interest for waste heat energy harvesting,2 energy efficiency improvement,3 and powering of remote sensors and electronic applications.4 Among the many potential applications, thermoelectrics for power generation or temperature control in micro-electronic device5 are especially attractive since heat plays a key role to degrade the device performance.6

Conventional thermoelectric modules, sometimes referred to as “bulk” modules, have been used for decades in commercial power generation (ex, Hi-z)7 and temperature control of electronics.8 However, as the size and power density requirements are dramatically changing for electronics, conventional bulk thermoelectric technology will lose its advantages for the microelectronic applications. Conversely, thin film thermoelectric modules focus on localized temperature control as well as self-sustained power generation.9,10

These thin film thermoelectric modules take the advantages of semiconductor processing techniques to create a nanostructured thermoelectric thin film.11 As the Internet of Things (IoT) develops, more embedded thermoelectric energy harvesting modules are needed for a variety of applications due to its advantage of compactness and free of maintenance compared with using regular battery.12 The current type of the thin film thermoelectric module that commercially available is based on bismuth telluride alloy which has good performance at room temperature.13 For energy harvesting applications in nuclear or other harsh environments, electronic systems must survive high temperatures and thermoelectric devices based on high temperature materials other than bismuth telluride are desirable.

Filled skutterudite is a state of the art high temperature thermoelectric material which is known as a phonon glass electron crystal-PGEC system.14 Nolas et al.15 reported on bulk Yb filled skutterudite and found ZT close to 1 at 600 K for Yb0.15CoSb2.6. Shi et al.16 investigated multi-filled skutterudite bulk material and got maximum ZT of 1.7 at 850 K. For microdevice applications,17 it is essential to find these promising “bulk” properties also in skutterudite thin films. Thermoelectric modules based on thin film skutterudite material are still under laboratory research level.18,19 Anno et al.20,21 reported the grown of CoSb3 thin film on Si(100) and GaAs (100) substrate using rf-sputtering. In another study, Savchuk et al.22 studied the structural, electrical, and thermal properties of binary skutterudite CoSb3 thin films deposited using sputtering. The temperature of the transition from the amorphous to crystalline state was found to be around 428 K. On the other hand, Caylor et al.23 presented skutterudite (CoSb3 and IrSb2) thin films of high phase purity and crystallinity. Zeipl et al.24,25 studied thin layers of Yb filled CoSb3 prepared by pulsed laser deposition (PLD) with the best results obtained on quartz substrate at 470 K. Kumar et al.26 reported In and Yd double filled CoSb3 thin film using PLD and obtained maximum power factor of 0.68 W/m K2 at 700 K. However, all the studies reported on thin film skutterudite did not provide the figure of merit at high temperatures which impeded the development for high temperature applications.

In this work, the preparation of Yb filled skutterudite thin film growth using DC magnetron sputtering is summarized

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and thermoelectric properties including thermal conductivity, electrical conductivity, Seebeck coefficient, and figure of merit are reported from room temperature to 700 K. The selection of using DC magnetron sputtering lies in a high deposition rate and it also maintains the target material composition. More importantly, magnetron sputtering produces a dense microstructure which surpasses most of other thin film deposition techniques. The parameters of DC magnetron sputtering and post heat treatment on sputtered sample have been optimized experimentally. Yb filled CoSb3 has for the first time been successfully deposited using sputtering and characterized comprehensively. This result is reported in the following manner: Section II introduces the experiment method used in this work; Sec. III discusses in detail about the phase, microstructure, and thermoelectric properties; Sec. IV concludes the work of Yb filled skutterudite prepared with of DC magnetron sputtering.

II. METHODS

Thermoelectric performance is characterized by the dimensionless figure of merit $ZT = \frac{\sigma S^2 T}{\kappa}$ and power factor $PF = \sigma S^2$, where $S$ is the Seebeck coefficient (V/K), $\sigma$ is the electrical conductivity (S/m), $\kappa$ is the thermal conductivity (W/m K), and $T$ is the absolute temperature in Kelvin (K). The electrical conductivity $\sigma = ne\mu$ is given by carrier concentration $n$, carrier mobility $\mu$, and electron charge $e$. Carrier concentration and mobility can be determined by measuring the Hall coefficient $R_H$. For materials in which electrons are the primary carriers, $R_H = -1/ne$. Combining the Hall Effect coefficient and electrical conductivity, the mobility of such materials can be expressed as $\mu = -\sigma R_H$. An expression for the Seebeck coefficient for $n$-type thermoelectric material is obtained by Busch and Winkler as

$$S = -\frac{k}{e} \left( \frac{5}{2} + r - \ln \frac{n}{N_c} \right).$$

Here, $k$ is Boltzmann’s constant, $r$ is the exponent of the power function in the energy-dependent relaxation time expression, and $N_c$ is the effective density of states in the valence band. As can be seen, the Seebeck coefficient is affected by carrier concentration, $n$.

Used in this study are four-inch-diameter undoped (100) silicon wafers (University Wafer, Inc.). The 350- to 400-μm-thick silicon wafers with a resistivity of more than 1 MΩ cm were initially oxidized at 670 K for 2 minutes to get a 240-nm-thick silicon dioxide layer using pressure enhanced chemical vapor deposition PECVD (Trion Technology, Inc.). The target material is purchased from LTS Research Laboratories, Inc. The films were deposited at room temperature without substrate heating.

After pumping overnight, the process chamber had a base pressure of \(5 \times 10^{-6}\) Torr. The thickness of thin films was controlled by a film thickness monitor/controller during the deposition. Table I summaries some of the parameters used in the sputtering process.

Table II summarizes all of the samples in this work including target and sputtered samples as well as their heat treated counterparts. The thickness of the film is measured by Stylus Profilometry (Bruker, IL, USA). Target material T1 is as-quenched filled skutterudite and T2 is a sample heat treated at 1020 K for 120 h Y1 is as sputtered filled skutterudite thin film and Y2 through Y6 are the several thicknesses thin film samples with various heat treatments.

The sample phase was analyzed by X-ray diffraction (XRD) (Ultimate III, Rigaku, TX, USA) utilizing Cu Kα radiation and energy-dispersive X-ray spectroscopy (EDS) (JEOL 7600F, Tokyo, JP). The surface morphologies of the sample were observed using a scanning electric microscope (SEM) (JEOL 7600F, Tokyo, JP). The electrical conductivity was measured using a Keithley digital multimeter (Model 2700, Keithley Instruments, Inc., OH, USA) and the sample was heated from 300 to 400 K using a High Temperature Probe Station (MBE-Komponenten AO500, Germany). To investigate their contribution to electrical conductivity, the carrier concentration and Hall mobility were measured with a Hall Measurement System (8404, Lake Shore Cryotronics, Inc., OH, USA) using the Van der Pauw method. Seebeck coefficients were measured using a differential method in vacuum. The thermal conductivity was measured using 3ω method by a lock-in amplifier together with temperature coefficient of resistance (TCR) in a high temperature probe station.

III. RESULTS AND DISCUSSIONS

A. Phase composition of filled skutterudite thin film before and after heat treatment

Fig. 1 shows the XRD of the DC magnetron sputtered thin film as well as targets before and after heat treatment. As can be seen from the figure, the as quenched target (T1) basically contains Sb and CoSb2 phases, instead of a CoSb3 phase. The reason to choose “as quenched” target is a

<table>
<thead>
<tr>
<th>Sample</th>
<th>Material</th>
<th>Condition</th>
<th>Heat treatment</th>
<th>Thickness (nm)</th>
</tr>
</thead>
<tbody>
<tr>
<td>T1</td>
<td>Yb,CoSb3</td>
<td>Hot press</td>
<td>N/A</td>
<td>Target</td>
</tr>
<tr>
<td>T2</td>
<td>Yb,CoSb3</td>
<td>Hot press</td>
<td>1020 K, 120 h</td>
<td>Target</td>
</tr>
<tr>
<td>Y1</td>
<td>Yb,CoSb3</td>
<td>Sputtering</td>
<td>N/A, as deposited</td>
<td>860</td>
</tr>
<tr>
<td>Y2</td>
<td>Yb,CoSb3</td>
<td>Sputtering</td>
<td>620 K, 2 h</td>
<td>860</td>
</tr>
<tr>
<td>Y3</td>
<td>Yb,CoSb3</td>
<td>Sputtering</td>
<td>870 K, 4 h</td>
<td>860</td>
</tr>
<tr>
<td>Y4</td>
<td>Yb,CoSb3</td>
<td>Sputtering</td>
<td>1020 K, 24 h</td>
<td>860</td>
</tr>
<tr>
<td>Y5</td>
<td>Yb,CoSb3</td>
<td>Sputtering</td>
<td>1020 K, 24 h</td>
<td>300</td>
</tr>
<tr>
<td>Y6</td>
<td>Yb,CoSb3</td>
<td>Sputtering</td>
<td>1020 K, 24 h</td>
<td>130</td>
</tr>
</tbody>
</table>
consideration of production availability and price. Heat treatment on the “as quenched” target material at 1020 K (T2) gives mainly CoSb$_3$ phase with a little residual CoSb$_2$ phase. The as-sputtered thin film (Y1) is measured as amorphous due to the fact that the substrate temperature during sputtering is kept at room temperature. When heat treated at 620 K (Y2), the thin film turns from amorphous into crystalline. The crystallized thin film shows a main peak of CoSb$_3$ which is quite different from the bulk material since bulk filled skutterudite needs higher and longer temperatures to be fully turned into CoSb$_3$ phase. The reason for this is that the thin film after the sputtering process is more uniform and the diffusion occurs more readily due to the lower dimension in thin film sample. Higher temperature heat treatment on 870 K (Y3) and 1020 K (Y4) can make the film fully crystalline and possibly facilitate the Yb diffusion into the CoSb$_3$ cages which is shown in Fig. 1(b). Filled skutterudite and skutterudite (CoSb$_3$) are the similar phases and the only difference is the left shift of the peaks in filled skutterudites. As shown in Fig. 1(b), thin film skutterudite clearly shows the left shift of peaks which is originated from the diffusion of Yb element into CoSb$_3$ cages. After the diffusion of Yb element into CoSb$_2$ cage, the lattice constant of the sample will increase and the peak shown on XRD graph will shift towards left (smaller $\theta$). As temperature increases in thin film sample heat treatment, more shift of XRD peak is found which is due to the enhanced diffusion of Yb element into CoSb$_3$ cage at higher temperature. The confirmation of Yb element from EDS (Fig. 2) together with the lattice structure changed (Fig. 1(b)) suggested the Yb filled skutterudite phase is formed in thin film sample after proper heat treatment. Overall, after 620 K heat treatment, the thin film turns from amorphous into crystalline and 1020 K with 24 h heat treatment gives best electrical properties as shown in Table III.

B. SEM results of dc-sputtered filled skutterudite thin film samples

Heat treatment is necessary for filled skutterudite samples in order to get the correct phase and better thermoelectric properties. As shown in Fig. 3(a), the as-deposited material is amorphous because during sputtering the substrate is at room temperature. This is typically true for thin film grown through sputtering. A 620 K heat treatment for 2 h (Y2) turns the thin film into crystal as one can see from above XRD (Fig. 1). Figs. 3(c) and 3(d) show that higher temperature heat treatment gives larger grain size which will enhance Hall mobility as shown in Table III.

C. Thermoelectric properties of dc-sputtered filled skutterudite thin film samples

1. Electrical conductivity

Room temperature electrical conductivity as well as the carrier concentration and mobility were characterized using van der pawu method.

Table III shows the sputtered thin film electrical properties from samples annealed at selected temperatures. The relative uncertainties of carrier concentration, Hall mobility,
and conductivity measurement are 10%, 2%, and 8%. After sputtering, the thin film samples show a very high electrical conductivity due to high carrier concentration. This is because the bonding between Co and Sb has not been fully formed which gives high carrier concentrations, while the mobility 0.07 cm²/V s is very low. After a 620 K heat treatment for 2 h (Y2), the CoSb₃ phase starts to form as seen in Fig. 1 and mobility increases to 1.5 cm²/V s. Higher temperature heat treatments (Y3 and Y4) increase the mobility even more with some sacrifice of carrier concentration. Lower carrier concentration is beneficial to Seebeck coefficient as shown in Eq. (1). In fact, 1020 K heat treatment (Y6) fully crystallizes the sputtered thin film and has large carrier mobility. As a result, from now on an annealing temperature of 1020 K heat treatment will be used for our work.

Thin films of different thicknesses have been deposited using a DC magnetron sputtering machine with a constant sputtering rate. Hall Effect measurements reveal that carrier concentration and mobility both play important roles in electrical conductivity.

### 2. Seebeck coefficient

Fig. 5 shows the measured Seebeck coefficients for filled skutterudite thin films with various film thicknesses. Seebeck coefficients were measured using a differential method under vacuum by an MMR Seebeck S100 controller with a K20 temperature controller. Different from measurement of bulk material Seebeck coefficient, thin film material with SiO₂ insulation layer and Si substrate has been cut into a long bar shape (1 × 1 × 4 mm). The reference material used for measurement is constantan wire provided by the same company. By putting reference material and thin film material under same temperature difference, the generated voltages are recorded automatically by the machine. The electrical contact between the measurement stage and thin film sample is only at thermoelectric material layer in order to eliminate any Seebeck coefficient that may generate from Si substrate. Seebeck coefficient is an intrinsic property that associated with the material and can be calculated as $\Delta V/\Delta T$. The reference material constantan has a known Seebeck coefficient, and the Seebeck of thin film material could be inferred from

<table>
<thead>
<tr>
<th>Sample No.</th>
<th>Carrier concentration n (10¹⁸/cm³)</th>
<th>Hall mobility µ (cm²/V·s)</th>
<th>Conductivity $\sigma$ (10⁴ S/m)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Y1</td>
<td>140000</td>
<td>0.07</td>
<td>16</td>
</tr>
<tr>
<td>Y2</td>
<td>5000</td>
<td>1.5</td>
<td>12</td>
</tr>
<tr>
<td>Y3</td>
<td>12</td>
<td>7.6</td>
<td>0.15</td>
</tr>
<tr>
<td>Y4</td>
<td>8.3</td>
<td>89</td>
<td>1.2</td>
</tr>
</tbody>
</table>

Electrical conductivity measurements for samples heat treated at 1020 K at temperatures of 300 to 770 K in vacuum are shown in Fig. 4. The measured temperature dependent electrical conductivities for sputtered thin film are shown in Fig. 4 with a relative uncertainty of 6%. As can be seen, the variation in electrical conductivity is significant in samples of different thicknesses. The 130 nm thin film (Y6) has the smallest electrical conductivity due to its lower carrier concentration. The 300 nm and 860 nm thin films (Y5 and Y4) have higher conductivities with a higher carrier concentration level.

**TABLE III. Room temperature Hall Effect for the 860 nm thin film at different heat treatment temperatures.**

![Fig. 3. SEM surface image of filled skutterudite thin film (a) as deposited Y1 sample, (b) 620 K heat treated Y2 sample, (c) 870 K HT Y3 sample, and (d) 1020 K HT Y4 sample.](#)
coefficient starts to decrease. Generally as temperature increases, the Seebeck coefficient will increase in magnitude because the ratio of effective density of state to carrier concentration $N_e/n$ in Eq. (1) is proportional to $\exp(kT)$. However, for 130 nm thin film (Y6) sample, the Seebeck coefficient starts to decrease around 600 K which may due to the carrier energy filtering effect that has been caused by the potential barriers at grain boundaries.\textsuperscript{21} The fact that the Seebeck coefficient is negative in Fig. 5 indicates that Yb doped CoSb\textsubscript{3} thin film is an $n$-type semiconductor, which also agrees with the Hall Effect measurement.

### 3. Thermal conductivity

One popular technique in the thermal conductivity measurement is a 3$\omega$-method, in which a thin metal strip evaporated on the sample acts as a heat source and a thermometer. Thermal conductivity was measured though the 3$\omega$ method (invented by Cahill \textit{et al.}\textsuperscript{32,33}) from room temperature up to 700 K by depositing Au strip on top of sample. The heater is driven with AC current at frequency $\omega$, which causes the electrical resistance of heat source to oscillate at frequency $2\omega$. By monitoring the AC voltage as a function of the frequency of the applied AC current, thermal conductivity can be determined. Prior to the Au strip deposition, a thin of silicon oxide layer is grown by PECVD for electrical insulation.

The calculations of the thermal conductivity $k_{film}$ of the thin films are carried out from the experimental data plotted in Fig. 6(b) in accordance with the method used by Lee and Cahil\textsuperscript{34} using a simplified one-dimensional model

$$k_{film} = \frac{P_f \cdot t}{w \cdot \Delta T_{film}},$$

where $P_f$ is the supplied power per unit length of the narrow metal heater thermometer of the width $w$, $t$ is the thickness of the tested thin film, $\Delta T_{film}$ is the increase of the temperature oscillations due to the thin film with respect to the reference sample. Fig. 6 illustrates typical frequency dependent temperature oscillations in the sample containing the Yb filled CoSb\textsubscript{3} thin film and reference samples. The calculation of the thermal conductivity using Eq. (2) gives a value of about 2–3 W/mK at room temperature, which is 2 to 3 times lower than for the bulk material.

Temperature dependent thermal conductivity is measured similarly using 3$\omega$ method with the example shown in Fig. 6. The relative uncertainty of measured temperature dependent thermal conductivity is 15%. At each temperature point, a frequency sweep is needed for the $\Delta T_{film}$ calculation for both thin film sample and reference sample. The TCR of e-beam evaporated gold is very stable up to 700 K and the resistivity can be calculated based on the measured TCR and room temperature resistivity. By applying Eq. (2), thermal conductivity was calculated and plotted in Fig. 7 for the thin films with different thicknesses. As temperature increases, all three films tend to decrease in thermal conductivity because phonon scattering is enhanced at higher temperatures. The thinner samples of 130 nm and 300 nm (Y6 and Y5) have a slightly lower thermal conductivity than the 860 nm thin film.
which may be due to the enhanced phonon scattering by grain interface and boundary in thin films.

4. Figure of merit, ZT

The figure of merit $ZT$ value of the sample can be estimated by combining the electrical properties, Seebeck coefficient, and thermal conductivity. Fig. 8 shows the $ZT$ for Yb filled CoSb$_3$ thin film with different thicknesses. The highest $ZT$ is achieved with the 130 nm thick sample (Y6) because it has much higher Seebeck coefficient even if its electrical conductivity is slightly lower than the other samples. Also, the thermal conductivity of the Y6 sample is lower than that of the Y4 sample. These results show the figure of merit does not significantly depend on the thin film thickness at lower temperatures. However, at each deposition and heat treatment, the carrier concentration and mobility do change a lot. Generally, with the same carrier concentration and mobility, thinner films may have higher figures of merit due to lower thermal conductivity caused by enhanced phonon scattering by boundaries.

Figures of merit of sputtered Yb doped CoSb$_3$ in this work are found to be between half to one third of the bulk material reported by Nolas et al.\textsuperscript{15} The lower $ZT$ in thin film mainly comes from the lower mobility. In bulk material, the mobility can be several thousand cm$^2$/V s which is two orders of magnitude higher than thin film in this work. Higher temperature with longer heat treatment time may help increase the mobility but could also induce crack in the thin film if heating/cooling process is not well controlled.

IV. CONCLUSIONS

Filled skutterudite is a state of the art high temperature thermoelectric material and in this work for the first time Yb filled CoSb$_3$ skutterudite thin films have been reported using DC magnetron sputtering method. DC magnetron sputtering is adopted due to its high deposition rate and the maintenance of target material composition. More importantly, magnetron sputtering provides denser microstructure which surpasses most of the other thin film deposition techniques. The parameters of DC magnetron and post heat treatment on sputtered samples have been optimized experimentally and Yb filled CoSb$_3$ thermoelectric properties have been characterized.

Electrical conductivity, Seebeck coefficient, thermal conductivity, and figure of merit are characterized from 300 K to 700 K. XRD, SEM, and EDS of the different thicknesses samples at three kinds of heat treatment conditions are obtained to assess the phase composition and crystallinity of thin film samples under different heat treatment temperatures. In this work, 1020 K heat treatment was adopted for thin film post process due to the high degree of crystallinity as well as avoiding reverse heating effect. Carrier concentrations and
Hall mobility are obtained from Hall Effect measurements, which provide further insight into the electrical conductivity and Seebeck coefficient mechanisms. The “as-sputtered” sample has a huge carrier concentration which gives very high electrical conductivity. However, low Hall mobility in the “as-sputtered” sample makes it unsuitable for thermoelectric application. Among the three types of heat treatment, 1020 K gives the best Hall mobility. The Seebeck coefficient is inversely dependent on carrier concentration, so the low carrier concentration in the 130 nm sample increases the Seebeck coefficient significantly and overall gives the best figure of merit. Since the carrier concentration plays a trade-off role in thermoelectric material, it should be optimized to give better ZT. It seems in this work that a low carrier concentration is more favorable due to its large increase in thermoelectric material, which provides further insight into the electrical conductivity as well. Hall mobility are obtained from Hall Effect measurements, which provide further insight into the electrical conductivity and Seebeck coefficient mechanisms. The “as-sputtered” sample has a huge carrier concentration which gives very high electrical conductivity. However, low Hall mobility in the “as-sputtered” sample makes it unsuitable for thermoelectric application. Among the three types of heat treatment, 1020 K gives the best Hall mobility. The Seebeck coefficient is inversely dependent on carrier concentration, so the low carrier concentration in the 130 nm sample increases the Seebeck coefficient significantly and overall gives the best figure of merit. Since the carrier concentration plays a trade-off role in thermoelectric material, it should be optimized to give better ZT. It seems in this work that a low carrier concentration is more favorable due to its large increase in thermoelectric material, which provides further insight into the electrical conductivity as well.

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2. G. J. Snyder and E. S. Toberer, Nature Mater. 7(2), 105 (2008).